



July 1, 2003

To: Commissioner of Patents and Trademarks  
Washington, D.C. 20231

ATTN: Group Art Unit 2815 J. R. Diaz

From: Stephen B. Ackerman, Reg. No. 37,761  
20 McIntosh Drive  
Poughkeepsie, N. Y. 12603

Serial No. 09/764,242 01/19/2001

Wong

A FILL PATTERN IN KERF AREAS TO PREVENT LOCALIZED  
NON-UNIFORMITIES OF INSULATING LAYERS AT DIE  
CORNERS ON SEMICONDUCTOR SUBSTRATES

Group Art Unit: 2815 J. R. Diaz

RESPONSE TO PATENT OFFICE ACTION

Dear Sir or Madam:

The Commissioner is hereby authorized to charge payment of any additional fees involved with added Claims and the like to Deposit Account No. 19-0033.

In response to Office Action dated April 24, 2003, please consider the following remarks.

#### CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the U. S. Postal Service as first class mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231, on July 24 2003.

Stephen B. Ackerman, Reg. No. 37,761

Signature

Date

7/24/03

#15/Response  
8/7/03  
Smith

TECHNOLOGY CENTER 2800

JUL 30 2003

RECEIVED